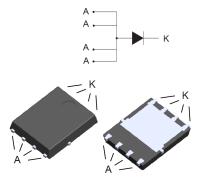




Datasheet

120 V, 30 A power Schottky rectifier



PowerFLAT™ 5x6 (non-contractual)

Features

- Very small conduction losses
- Negligible switching losses
- Extremely fast switching
- Low thermal resistance
- Avalanche capability specified
- ECOPACK[®]2 compliant

Applications

- Switching diode
- SMPS
- DC/DC converter
- LED lighting
- Notebook adapter

Description

This power Schottky is suited for switch mode power supply and high frequency DC to DC converters.

Packaged in PowerFLAT[™] 5x6, the STPS30120DJF is optimized for use in low voltage high frequency inverters, free-wheeling and polarity protection applications.

PowerFLAT[™] is a trademark of STMicroelectronics.

Product status link				
STPS30120DJF				
Product summary				
Symbol	Value			
I _{F(AV)}	30 A			
V _{RRM}	120 V			
T _j (max.)	150 °C			
V _F (typ.)	0.68 V			



1 Characteristics

Table 1. Absolute Ratings (limiting values at 25 °C, unless otherwise specified, anode terminals short circuited)

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage		120	V
I _{F(RMS)}	Forward rms current		45	Α
I _{F(AV)}	Average forward current, δ = 0.5, square wave	T _C = 80 °C	30	Α
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal	200	Α
P _{ARM}	Repetitive peak avalanche power	t _p = 10 μs , T _j = 125 °C	900	W
T _{stg}	Storage temperature range		-65 to +175	°C
Тj	Maximum operating junction temperature ⁽¹⁾			°C

1. $(dP_{tot'}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameters

Symbol	Parameter	Max. value	Unit
R _{th(j-c)}	Junction to case	2.5	°C/W

For more information, please refer to the following application note :

AN5046 : Printed circuit board assembly recommendations for STMicroelectronics PowerFLAT™ packages

Table 3. Static electrical characteristics (anode terminals short circuited)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Poversa lookago eurrent	T _j = 25 °C	V _R = V _{RRM}	-		35	μA
IR V	I _R ⁽¹⁾ Reverse leakage current	T _j = 125 °C	VR - VRRM	-	5.5	16	mA
	V _F ⁽²⁾ Forward voltage drop	T _j = 25 °C	I _F = 15 A	-		0.84	
V (2)		T _j = 125 °C		-	0.61	0.67	V
VF (=)		T _j = 25 °C	I _F = 30 A			0.92	V
		T _j = 125 °C			0.68	0.75	

1. Pulse test: $t_p = 5 ms$, $\delta < 2\%$

2. Pulse test: t_p = 380 µs, δ < 2%

To evaluate the conduction losses use the following equation:

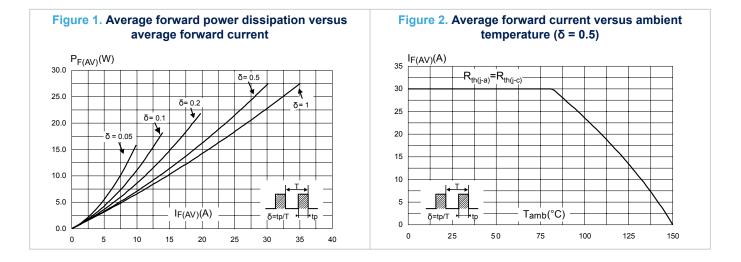
 $P = 0.61 \times I_{F(AV)} + 0.005 I_{F}^{2} (RMS)$

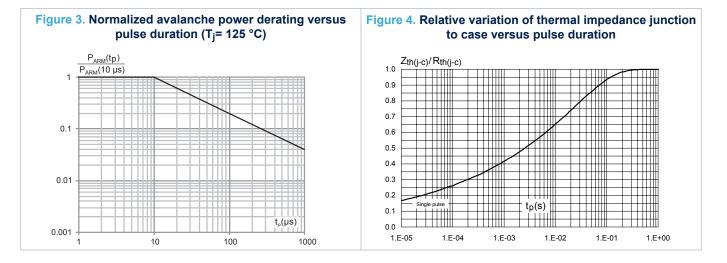
For more information, please refer to the following application notes related to the power losses :

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode



1.1 Characteristics (curves)





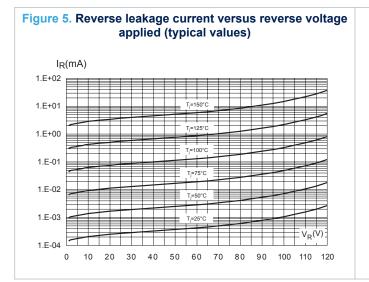
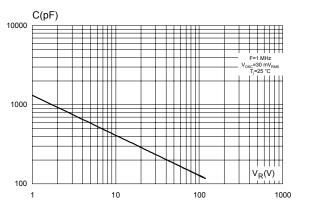
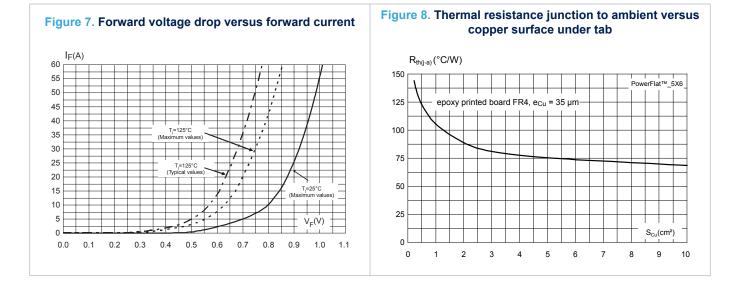


Figure 6. Junction capacitance versus reverse voltage applied (typical values)







DS6255 - Rev 7 ed from Arrow.com.

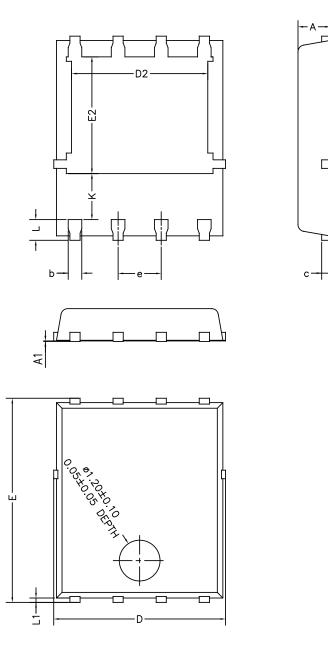
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

2.1 PowerFLAT[™] 5x6 package information

- Epoxy meets UL 94,V0
- Cooling method: by conduction (C)





Bottom view

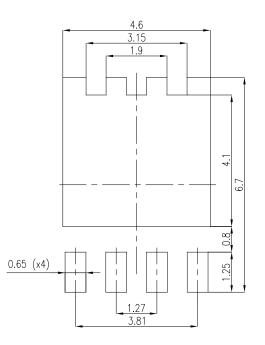


Top view

Dimensions							
5 /	Millimeters			Inches (for reference only)			
Ref	Min.	Тур.	Max.	Min.	Тур.	Max.	
A	0.80		1.00	0.031		0.039	
A1	0.00		0.05	0.000		0.002	
b	0.30		0.50	0.01		0.02	
с		0.25			0.010		
D	4.80		5.40	0.189		0.212	
D2	3.91		4.45	0.154		0.175	
е		1.27			0.050		
E	5.90		6.35	0.232		0.250	
E2	3.34		3.70	0.138		0.146	
L	0.50		0.80	0.020		0.031	
К	1.10		1.575	0.015		0.023	
L1	0.05	0.15	0.25	0.002	0.006	0.009	

Table 4. PowerFLAT™ 5x6 mechanical data

Figure 10. PowerFLAT™ 5x6 recommended footprint (dimensions are in mm)





3 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS30120DJF-TR	PS30 120	PowerFLAT 5x6	0.095 g	3000	Tape and reel

Revision history

Table 6. Document revision history

Date	Revision	Changes
18-May-2009	1	First issue.
09-Nov-2009	2	Updated Table 1.
25-Feb-2010	3	Corrected order code and marking in Table 6.
30-Jul-2010	4	Replace Power QFN with PowerFLAT.
20-May-2011	5	Updated package graphics. Added mention of terminals to captions of Table 2 and Table 4. Updated base quantity and marking in Table 6. Added Figure 12.
28-May-2018	6	Updated PARM value and removed "Normalized avalanche power derating" curves.
08-Feb-2019	7	Updated Figure 9. PowerFLAT™ 5x6 package outline (non-contractual), Table 4. PowerFLAT™ 5x6 mechanical data and Section Cover image.



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